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MC10H159

Quad 2-Input Multiplexer

(Inverting)

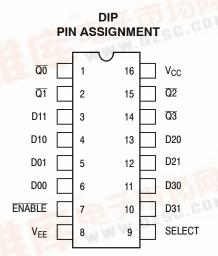
Description

The MC10H159 is a quad 2-input multiplexer with enable. This MECL $10H^{TM}$ part is a functional/pinout duplication of the standard MECL $10K^{TM}$ family part, with 100% improvement in propagation delay and no increase in power-supply current.

Features

- Propagation Delay, 1.5 ns Typical
- Power Dissipation, 218 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K Compatible
- Pb-Free Packages are Available*

TRUTH TABLE							
Enable	Select	D0	D1	Q			
L	L	Х	L	Н			
L	L	Х	Н	L			
L	Н	L	Х	Н			
L	Н	Н	Х	L			
Н	Х	Х	Х	L			



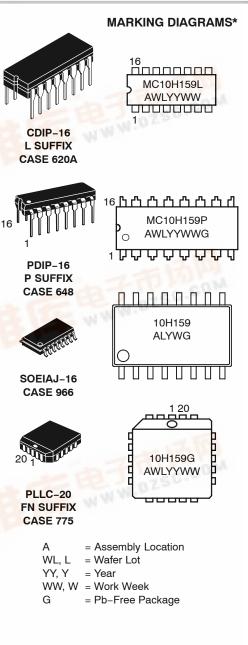
For PLCC pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques



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*For additional marking information, refer to Application Note AND8002/D.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

dzsc.com

Table 1. MAXIMUM RATINGS

Symbol	Characteristic	Rating	Unit
V_{EE}	Power Supply (V _{CC} = 0)	-8.0 to 0	Vdc
VI	Input Voltage (V _{CC} = 0)	0 to V _{EE}	Vdc
l _{out}	Output Current – Continuous – Surge	50 100	mA
T _A	Operating Temperature Range	0 to +75	°C
T _{stg}	Storage Temperature Range – Plastic – Ceramic	–55 to +150 −55 to +165	O° O°

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

Table 2. ELECTRICAL CHARACTERISTICS (V_{EE} = -5.2 V $\pm 5\%$) (Note 1)

		C	0	25 °		75 °		
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
Ι _Ε	Power Supply Current	-	58	-	53	-	58	mA
l _{inH}	Input Current High Pin 9 Pins 3–7 and 10–13		475 515	-	295 320	-	295 320	μΑ
l _{inL}	Input Current Low	0.5	-	0.5	-	0.3	-	μΑ
V _{OH}	High Output Voltage	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
V _{OL}	Low Output Voltage	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
V _{IH}	High Input Voltage	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
VIL	Low Input Voltage	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

 Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50 Ω resistor to -2.0 V.

Table 3. AC PARAMETERS

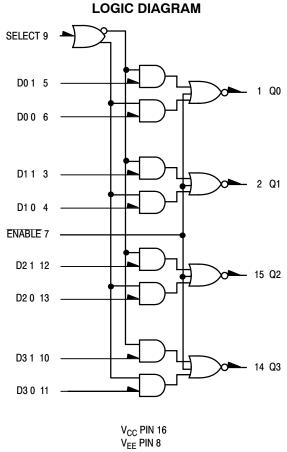
		0 °		25 °		75 °		
Symbol	Characteristic	Min	Мах	Min	Max	Min	Max	Unit
t _{pd}	Propagation Delay							ns
	Data	0.5	2.2	0.5	2.2	0.5	2.2	
	Select	1.0	3.2	1.0	3.2	1.0	3.2	
	Enable	1.0	3.2	1.0	3.2	1.0	3.2	
t _r	Rise Time	0.5	2.2	0.5	2.2	0.5	2.2	ns
t _f	Fall Time	0.5	2.2	0.5	2.2	0.5	2.2	ns

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

APPLICATION INFORMATION

The MC10H159 is a quad two channel multiplexer with enable. It incorporates common enable and common data select inputs. The select input determines which data inputs are enabled. A high (H) level enables data inputs D0 0, D1

0, D2 0, and D3 0. A low (L) level enables data inputs D0 1, D1 1, D2 1, and D3 1. Any change on the data inputs will be reflected at the outputs while the enable is low. Input levels are inverted at the output.



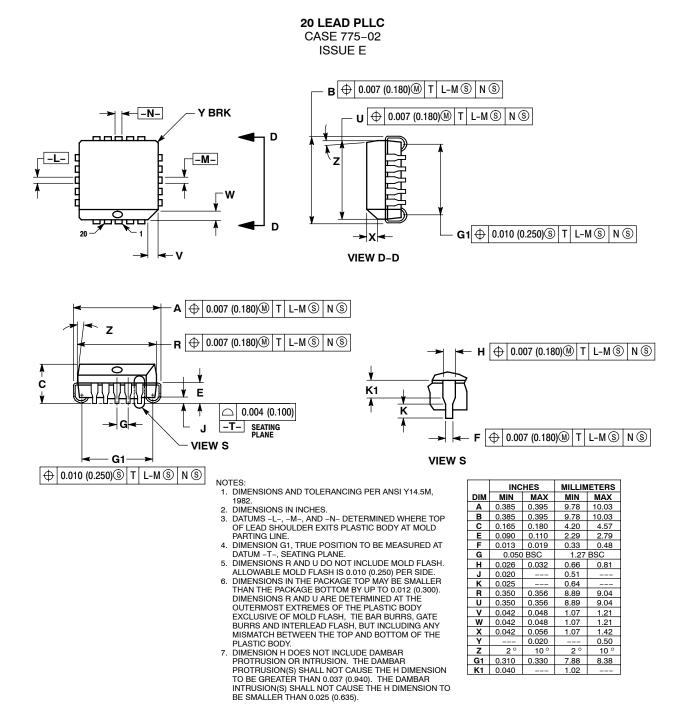
LOGIC DIAGRAM

ORDERING INFORMATION

Device	Package	Shipping [†]
MC10H159FN	PLLC-20	46 Units / Rail
MC10H159FNG	PLLC-20 (Pb-Free)	46 Units / Rail
MC10H159FNR2	PLLC-20	500 / Tape & Reel
MC10H159FNR2G	PLLC-20 (Pb-Free)	500 / Tape & Reel
MC10H159L	CDIP-16	25 Unit / Rail
MC10H159M	SOEIAJ-16	50 Unit / Rail
MC10H159MG	SOEIAJ-16 (Pb-Free)	50 Unit / Rail
MC10H159MEL	SOEIAJ-16	2000 / Tape & Reel
MC10H159MELG	SOEIAJ-16 (Pb-Free)	2000 / Tape & Reel
MC10H159P	PDIP-16	25 Unit / Rail
MC10H159PG	PDIP-16 (Pb-Free)	25 Unit / Rail

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

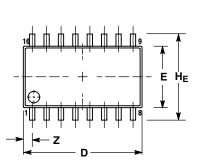
PACKAGE DIMENSIONS

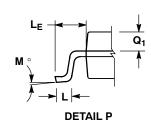


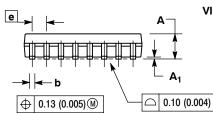
PACKAGE DIMENSIONS

SOEIAJ-16 CASE 966-01

ISSUE A

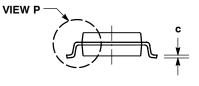




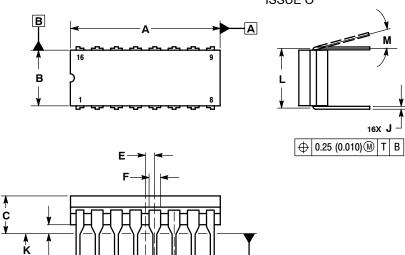


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CDIP-16 L SUFFIX CERAMIC DIP PACKAGE CASE 620A-01 ISSUE O



G

- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER. 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE. 4. TERMINAL INLINEERS ARE SHOWN FOR
- PER SIDE. 4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY. 5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

10 22 0.10 (0.010).								
	MILLIN	IETERS	INCHES					
DIM	MIN	MAX	MIN	MAX				
Α		2.05		0.081				
A ₁	0.05	0.20	0.002	0.008				
b	0.35	0.50	0.014	0.020				
C	0.10	0.20	0.007	0.011				
D	9.90	10.50	0.390	0.413				
Е	5.10	5.45	0.201	0.215				
е	1.27	BSC	0.050 BSC					
HE	7.40	8.20	0.291	0.323				
L	0.50	0.85	0.020	0.033				
LE	1.10	1.50	0.043	0.059				
Μ	0 °	10 °	0 °	10 °				
Q ₁	0.70	0.90	0.028	0.035				
Z		0.78		0.031				

- NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL. 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC PORV
- BODY. THIS DRAWING REPLACES OBSOLETE CASE OUTLINE 620-10. 5

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
Е	0.050 BSC		1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100	BSC	2.54 BSC		
Н	0.008	0.015	0.21	0.38	
K	0.125	0.170	3.18	4.31	
L	0.300 BSC		7.62	BSC	
Μ	0 °	15°	0 °	15°	
Ν	0.020	0.040	0.51	1.01	

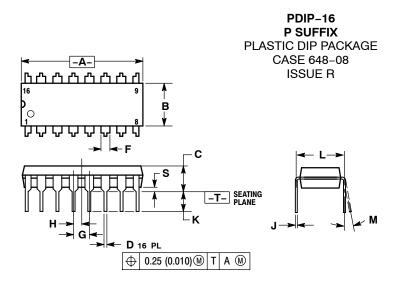
SEATING PLANE

Т

16X D

⊕ 0.25 (0.010)∭ T A

PACKAGE DIMENSIONS



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. CONTROLLING DIMENSION: INCH. 2.
- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL. 3
- DIMENSION B DOES NOT INCLUDE MOLD FLASH. ROUNDED CORNERS OPTIONAL. 5

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54	BSC	
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
Κ	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
М	0 °	10 °	0 °	10 °	
S	0.020	0.040	0.51	1.01	

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